

3.3V 128K X 8 CMOS SRAM (Center power and ground)

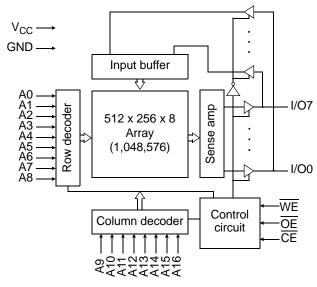
Features

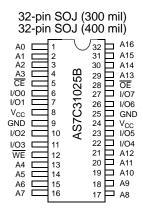
- Industrial and commercial temperatures
- Organization: 131,072 x 8 bits
- · High speed
- 10/12/15/20 ns address access time
- 5, 6, 7, 8 ns output enable access time
- Low power consumption: ACTIVE
 - 252 mW / max @ 10 ns
- Low power consumption: STANDBY
- 18 mW / max CMOS
- 6 T 0.18 u CMOS technology

- Easy memory expansion with \overline{CE} , \overline{OE} inputs
- Center power and ground
- TTL/LVTTL-compatible, three-state I/O
- JEDEC-standard packages
 - 32-pin, 300 mil SOJ
 - 32-pin, 400 mil SOJ
- ESD protection ≥ 2000 volts
- Latch-up current ≥ 200 mA

Pin arrangement

Logic block diagram





Selection guide

| | -10 | -12 | -15 | -20 | Unit |
|-----------------------------------|-----|-----|-----|-----|------|
| Maximum address access time | 10 | 12 | 15 | 20 | ns |
| Maximum output enable access time | 5 | 6 | 7 | 8 | ns |
| Maximum operating current | 70 | 65 | 60 | 55 | mA |
| Maximum CMOS standby current | 5 | 5 | 5 | 5 | mA |



Functional description

The AS7C31025B is a high-performance CMOS 1,048,576-bit Static Random Access Memory (SRAM) device organized as 131,072 x 8 bits. It is designed for memory applications where fast data access, low power, and simple interfacing are desired.

Equal address access and cycle times (t_{AA}, t_{RC}, t_{WC}) of 10/12/15/20 ns with output enable access times (t_{OE}) of 5, 6, 7, 8 ns are ideal for high-performance applications. The chip enable input \overline{CE} permits easy memory and expansion with multiple-bank memory systems.

When $\overline{\text{CE}}$ is high the device enters standby mode. A write cycle is accomplished by asserting write enable ($\overline{\text{WE}}$) and chip enable ($\overline{\text{CE}}$). Data on the input pins I/O0 through I/O7 is written on the rising edge of $\overline{\text{WE}}$ (write cycle 1) or $\overline{\text{CE}}$ (write cycle 2). To avoid bus contention, external devices should drive I/O pins only after outputs have been disabled with output enable ($\overline{\text{OE}}$) or write enable ($\overline{\text{WE}}$).

A read cycle is accomplished by asserting output enable (\overline{OE}) and chip enable (\overline{CE}) , with write enable (\overline{WE}) high. The chip drives I/O pins with the data word referenced by the input address. When either chip enable or output enable is inactive or write enable is active, output drivers stay in high-impedance mode.

All chip inputs and outputs are TTL-compatible, and operation is from a single 3.3 V supply. The AS7C31025B is packaged in common industry standard packages.

Absolute maximum ratings

| Parameter | Symbol | Min | Max | Unit |
|--|-------------------|-------|----------------|------|
| Voltage on V _{CC} relative to GND | V _{t1} | -0.50 | +5.0 | V |
| Voltage on any pin relative to GND | V_{t2} | -0.50 | $V_{CC} + 0.5$ | V |
| Power dissipation | P_{D} | _ | 1.0 | W |
| Storage temperature (plastic) | T _{stg} | -65 | +150 | ° C |
| Ambient temperature with V _{CC} applied | T _{bias} | -55 | +125 | ° C |
| DC current into outputs (low) | I _{OUT} | _ | 20 | mA |

NOTE: Stresses greater than those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions outside those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Truth table

| CE | WE | OE | Data | Mode |
|----|----|---------------|------------------|---|
| Н | X | X | High Z | Standby (I _{SB} , I _{SB1}) |
| L | Н | Н | High Z | Output disable (I _{CC}) |
| L | Н | L | D _{OUT} | Read (I _{CC}) |
| L | L | X | D_{IN} | Write (I _{CC}) |

Key: X = don't care, L = low, H = high.



Recommended operating conditions

| Parameter | Symbol | Min | Nominal | Max | Unit |
|-------------------------------|-------------------|------|---------|----------------|------|
| Supply voltage | V_{CC} | 3.0 | 3.3 | 3.6 | V |
| Input voltage | V_{IH} | 2.0 | _ | $V_{CC} + 0.5$ | V |
| input voltage | V_{IL} | -0.5 | _ | 0.8 | V |
| Ambient operating temperature | T_{A} | 0 | _ | 70 | ° C |
| 7 morem operating temperature | T_{A} | -40 | _ | 85 | ° C |

DC operating characteristics (over the operating range) 1

| | | | -1 | 10 | -] | 12 | -] | 15 | -20 | | |
|--------------------------------|-----------------|---|-----|-----|-----|-----|-----|-----|-----|-----|------|
| Parameter | Sym | Test conditions | Min | Max | Min | Max | Min | Max | Min | Max | Unit |
| Input leakage current | I _{LI} | $V_{CC} = Max$, $V_{IN} = GND$ to V_{CC} | _ | 1 | _ | 1 | _ | 1 | - | 1 | μА |
| Output leakage current | I _{LO} | $V_{CC} = Max, \overline{CE} = V_{IH},$ $V_{out} = GND \text{ to } V_{CC}$ | - | 1 | 1 | 1 | _ | 1 | 1 | 1 | μА |
| Operating power supply current | I_{CC} | $\begin{aligned} V_{CC} &= Max \\ \overline{CE} &\leq V_{IL}, f = f_{Max}, \\ I_{OUT} &= 0 mA \end{aligned}$ | - | 70 | I | 65 | - | 60 | I | 55 | mA |
| Standby power | I_{SB} | $\begin{aligned} &V_{CC} = Max \\ &\overline{CE} \ge V_{IH}, f = f_{Max} \end{aligned}$ | ı | 30 | 1 | 25 | - | 20 | | 20 | mA |
| supply current | I_{SB1} | $V_{CC} = Max$, $\overline{CE} \ge V_{CC}$ -0.2 V, $V_{IN} \le 0.2$ V or $V_{IN} \ge V_{CC}$ -0.2 V, f = 0 | 1 | 5 | 1 | 5 | 1 | 5 | - | 5 | mA |
| Output voltage | V _{OL} | $I_{OL} = 8 \text{ mA}, V_{CC} = \text{Min}$ | _ | 0.4 | _ | 0.4 | - | 0.4 | _ | 0.4 | V |
| Surput voltage | V _{OH} | $I_{OH} = -4 \text{ mA}, V_{CC} = \text{Min}$ | 2.4 | _ | 2.4 | _ | 2.4 | _ | 2.4 | _ | V |

Capacitance (f = 1 MHz, $T_a = 25^{\circ}$ C, $V_{CC} = NOMINAL)^2$

| Parameter | Symbol | Signals | Test conditions | Max | Unit |
|-------------------|------------------|--|--------------------------|-----|------|
| Input capacitance | C_{IN} | $A, \overline{CE}, \overline{WE}, \overline{OE}$ | $V_{IN} = 0 V$ | 5 | pF |
| I/O capacitance | C _{I/O} | I/O | $V_{IN} = V_{OUT} = 0 V$ | 7 | pF |

 V_{IL} = -1.0V for pulse width less than 5ns $V_{IH} = V_{CC} + 1.5V \ for pulse \ width \ less than 5ns$



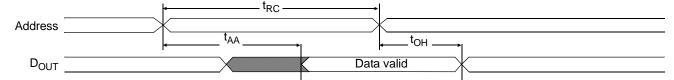
Read cycle (over the operating range)^{3,9}

| | | -10 | | -12 | | -15 | | -20 | | | |
|---------------------------------|------------------|-----|-----|-----|-----|-----|-----|-----|-----|------|-------|
| Parameter | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | Unit | Notes |
| Read cycle time | t _{RC} | 10 | _ | 12 | _ | 15 | _ | 20 | _ | ns | |
| Address access time | t _{AA} | _ | 10 | _ | 12 | - | 15 | _ | 20 | ns | 3 |
| Chip enable (CE) access time | t _{ACE} | _ | 10 | - | 12 | - | 15 | _ | 20 | ns | 3 |
| Output enable (OE) access time | t _{OE} | _ | 5 | - | 6 | - | 7 | _ | 8 | ns | |
| Output hold from address change | t _{OH} | 3 | _ | 3 | _ | 3 | _ | 3 | _ | ns | 5 |
| CE low to output in low Z | t _{CLZ} | 3 | - | 3 | - | 3 | - | 3 | 1 | ns | 4, 5 |
| CE high to output in high Z | t _{CHZ} | _ | 3 | - | 3 | - | 4 | _ | 5 | ns | 4, 5 |
| OE low to output in low Z | t _{OLZ} | 0 | _ | 0 | _ | 0 | _ | 0 | _ | ns | 4, 5 |
| OE high to output in high Z | t _{OHZ} | _ | 5 | - | 6 | - | 7 | _ | 8 | ns | 4, 5 |
| Power up time | t _{PU} | 0 | - | 0 | _ | 0 | - | 0 | _ | ns | 4, 5 |
| Power down time | t _{PD} | 1 | 10 | I | 12 | I | 15 | _ | 20 | ns | 4, 5 |

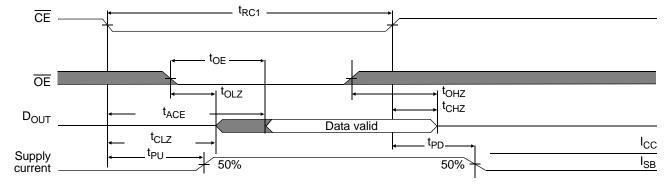
Key to switching waveforms



Read waveform 1 (address controlled)^{3,6,7,9}



Read waveform 2 (CE and OE controlled)^{3,6,8,9}

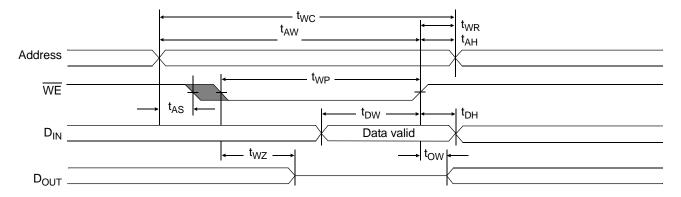




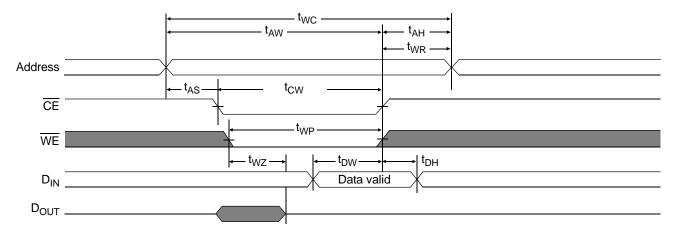
Write cycle (over the operating range) II

| | 0 0 / | -1 | 10 | -1 | 12 | -1 | 15 | -2 | 20 | | |
|--|-------------------|-----|-----|-----|-----|-----|-----|-----|-----|------|-------|
| Parameter | Symbol | Min | Max | Min | Max | Min | Max | Min | Max | Unit | Notes |
| Write cycle time | t _{WC} | 10 | - | 12 | - | 15 | _ | 20 | _ | ns | |
| Chip enable (\overline{CE}) to write end | t _{CW} | 8 | - | 9 | - | 10 | _ | 12 | _ | ns | |
| Address setup to write end | t _{AW} | 8 | - | 9 | - | 10 | _ | 12 | _ | ns | |
| Address setup time | t _{AS} | 0 | _ | 0 | _ | 0 | _ | 0 | _ | ns | |
| Write pulse width | t _{WP} | 7 | - | 8 | - | 9 | _ | 12 | _ | ns | |
| Write recovery time | t _{WR} | 0 | - | 0 | - | 0 | _ | 0 | _ | ns | |
| Address hold from end of write | t _{AH} | 0 | _ | 0 | _ | 0 | _ | 0 | _ | ns | |
| Data valid to write end | t_{DW} | 5 | - | 6 | - | 8 | _ | 10 | _ | ns | |
| Data hold time | t _{DH} | 0 | _ | 0 | _ | 0 | _ | 0 | _ | ns | 4, 5 |
| Write enable to output in high Z | t_{WZ} | _ | 5 | - | 6 | - | 7 | _ | 8 | ns | 4, 5 |
| Output active from write end | t _{OW} | 1 | _ | 1 | - | 1 | _ | 1 | _ | ns | 4, 5 |

Write waveform 1 (WE controlled)^{10,11}



Write waveform 2 ($\overline{\text{CE}}$ controlled)^{10,11}





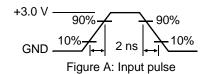
AC test conditions

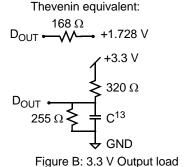
- Output load: see Figure B.

- Input pulse level: GND to 3.0 V. See Figure A.

- Input rise and fall times: 2 ns. See Figure A.

- Input and output timing reference levels: 1.5 V.





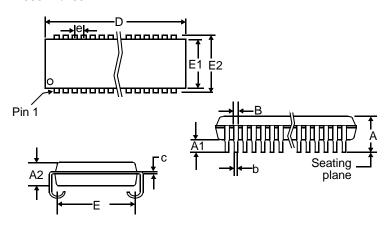
Notes

- 1 During V_{CC} power-up, a pull-up resistor to V_{CC} on \overline{CE} is required to meet I_{SB} specification.
- 2 This parameter is sampled, but not 100% tested.
- 3 For test conditions, see AC Test Conditions, Figures A and B.
- $4 t_{CLZ}$ and t_{CHZ} are specified with CL = 5 pF, as in Figure B. Transition is measured ± 500 mV from steady-state voltage.
- 5 This parameter is guaranteed, but not 100% tested.
- 6 WE is high for read cycle.
- 7 $\overline{\text{CE}}$ and $\overline{\text{OE}}$ are low for read cycle.
- 8 Address is valid prior to or coincident with $\overline{\text{CE}}$ transition low.
- 9 All read cycle timings are referenced from the last valid address to the first transitioning address.
- 10 N/A
- 11 All write cycle timings are referenced from the last valid address to the first transitioning address.
- 12 N/A
- 13 C = 30 pF, except all high Z and low Z parameters where C = 5 pF.



Package dimensions

32-pin SOJ 300 mil/400 mil



| | 32-pii 300 | n SOJ mil | 32-pin SOJ 400 mil | | |
|------------|---------------|--------------|-----------------------|-------|--|
| Symbol | Min | Min Max | | Max | |
| A | 0.128 | 0.145 | 0.132 | 0.146 | |
| A1 | 0.025 | - | 0.025 | - | |
| A2 | 0.095 | 0.105 | 0.105 | 0.115 | |
| В | 0.026 | 0.032 | 0.026 | 0.032 | |
| b | 0.016 | 0.020 | 0.015 | 0.020 | |
| c | 0.007 | 0.010 | 0.007 | 0.013 | |
| D | 0.820 | 0.830 | 0.820 | 0.830 | |
| E | 0.255 | 0.275 | 0.354 | 0.378 | |
| E 1 | 0.295 | 0.305 | 0.395 | 0.405 | |
| E2 | 0.330 | 0.340 | 0.435 | 0.445 | |
| e | 0.050 | BSC | 0.050 | BSC | |



Ordering Codes

| Package \ Access time | Temperature | 10 ns | 12 ns | 15 ns | 20 ns |
|-----------------------|-------------|------------------|------------------|------------------|------------------|
| 300-mil SOJ | Commercial | AS7C31025B-10TJC | AS7C31025B-12TJC | AS7C31025B-15TJC | AS7C31025B-20TJC |
| 300-11111 303 | Industrial | AS7C31025B-10TJI | AS7C31025B-12TJI | AS7C31025B-15TJI | AS7C31025B-20TJI |
| 400-mil SOJ | Commercial | AS7C31025B-10JC | AS7C31025B-12JC | AS7C31025B-15JC | AS7C31025B-20JC |
| 400-1111 303 | Industrial | AS7C31025B-10JI | AS7C31025B-12JI | AS7C31025B-15JI | AS7C31025B-0JI |

Note:

Add suffix 'N' to the above part number for lead free parts (Ex. AS7C31025B-10TJCN)

Part numbering system

| AS7C | X | 1025B | –XX | X | X | X |
|----------------|-------------------------------|------------------|----------------|---|---|---|
| SRAM prefix | Voltage: 3 = 3.3 V CMOS | Device number | Access time | | Temperature range C = commercial, 0° C to 70° C I = industrial, -40° C to 85° C | |





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Part Number: AS7C31025B

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